

限用物質含有情況標示聲明書

Declaration of the Presence Condition of the Restricted Substances Marking

設備名稱：觸控版模組 Equipment name		型號（型式）：TP - F/C 2266 等（詳見附表一） Type designation (Type)				
單元Unit	限用物質及其化學符號 Restricted substances and its chemical symbols					
	鉛Lead (Pb)	汞Mercury (Hg)	鎘Cadmium (Cd)	六價鉻 Hexavalent chromium (Cr+6)	多溴聯苯 Polybrominated biphenyls (PBB)	多溴二苯醚 Polybrominated diphenyl ethers (PBDE)
塑膠件 Circuit card	○	○	○	○	○	○
金屬件 Mechanical Parts	○	○	○	○	○	○
連接線 Cable	○	○	○	○	○	○
LCD螢幕 LCD	○	○	○	○	○	○
柔性電路板 Keypad Membrane, FPCB	○	○	○	○	○	○
標籤 Label	○	○	○	○	○	○
電路板 PCBA	○	○	○	○	○	○

備考1. “超出0.1 wt %” 及 “超出0.01 wt %” 係指限用物質之百分比含量超出百分比含量基準值。

Note 1: “Exceeding 0.1 wt %” and “exceeding 0.01 wt %” indicate that the percentage content of the restricted substance exceeds the reference percentage value of presence condition.

備考2. “○” 係指該項限用物質之百分比含量未超出百分比含量基準值。

Note 2: “○” indicates that the percentage content of the restricted substance does not exceed the percentage of reference value of presence.

備考3. “-” 係指該項限用物質為排除項目。

Note 3: The “-” indicates that the restricted substance corresponds to the exemption.

附表一

產品型號 :
TP - F/C 2266, 00DN047, 00DN048, 00DN049, 00DN050

(P) P/N: 3AD00553500



(2P) EC LEVEL: REV000

